Doc No. TT4-EA-10241

Revision. 2

Panasonic

MOS FET MTM982400BBF

Unit: mm

MTM982400BBF

Silicon N-channel MOSFET

For switching

■ Features

- Low drain-source On-state Resistance RDS(on) typ = $29 \text{ m}\Omega$ (VGS = 5.0 V)
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: CA

■ Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

1. Source 5. Drain
2. Source 6. Drain
3. Source 7. Drain
4. Gate 8. Drain

SC-111AA

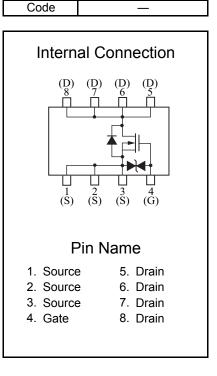
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JEITA

0.4

Parameter	Symbol	Rating	Unit
Drain-source Voltage	VDS	40	V
Gate-source Voltage	VGS	±20	V
Drain Current	ID	7	Α
Drain Current (Pulsed)	IDp	28	Α
Total Power dissipation *1	PD	2	W
Channel Temperature	Tch	150	°C
Operating Ambient Temperature	Topr	-40 to +85	°C
Storage Temperature Range	Tstg	-55 to +150	°C

Note: *1 Measuring on ceramic board at 50 mm \times 50 mm \times 1.0 mm.



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■ Electrical Characteristics Ta = 25°C ± 3°C

Static Characteristics

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Drain-source Breakdown Voltage	VDSS	ID = 1 mA, VGS = 0 V	40			V
Zero Gate Voltage Drain Current	IDSS	VDS = 40 V, VGS = 0 V			10	μΑ
Gate-source Leakage Current	IGSS	VGS = ±16 V, VDS = 0 V			±10	μΑ
Gate-source threshold Voltage	Vth	ID = 1.0 mA, VDS = 10.0 V	1.0		2.5	V
Drain-source On-state Resistance *1	RDS(on)1	ID = 7 A, VGS = 10 V		16	23	mΩ
	RDS(on)2	ID = 3.5 A, VGS = 5.0 V		29	40	
Forward transfer admittance *1	Yfs	ID = 7 A, VDS = 10 V	4.0			S
Input Capacitance	Ciss			1 750		pF
Output Capacitance	Coss	VDS = 10 V, VGS = 0 V, f = 1 MHz		150		
Reverse Transfer Capacitance	Crss			90		
Turn-on Delay Time *1,*2	td(on)	VDD = 25 V, VGS = 0 to 10 V,		17		no
Rise Time *1,*2	tr	ID = 3.5 A		9		ns
Turn-off Delay Time *1,*2	td(off)	VDD = 25 V, VGS = 10 to 0 V,		94		ns
Fall Time *1,*2	tf	ID = 3.5 A		33		113

Note: 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

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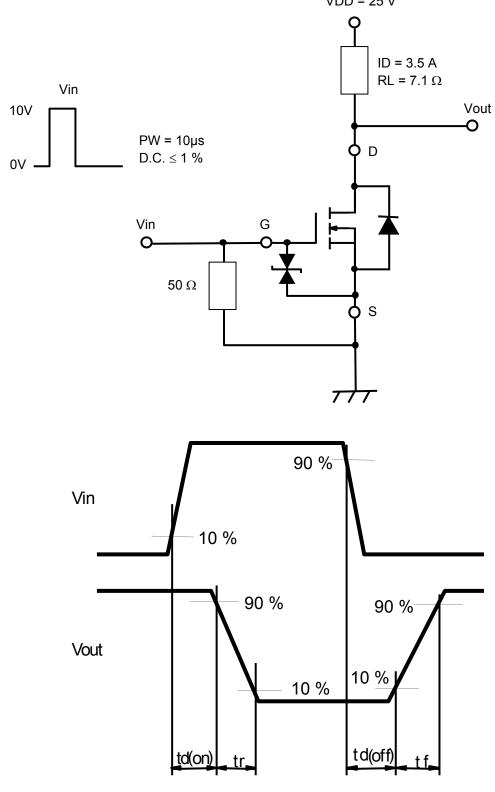
Established: 2007-12-18 : 2013-09-10 Revised

^{2. *1} Pulse test

^{*2} Measurement circuit for Turn-on Delay Time/Rise Time/Turn-off Delay Time/Fall Time

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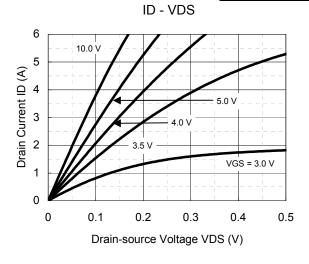
*2 Measurement circuit for Turn-on Delay Time/Rise Time/Turn-off Delay Time/Fall Time VDD = 25 V

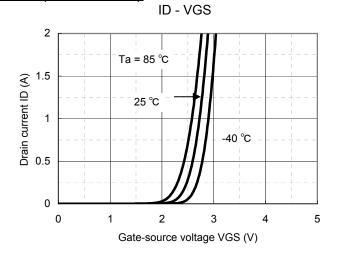


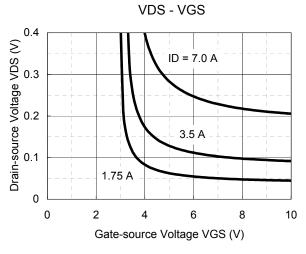
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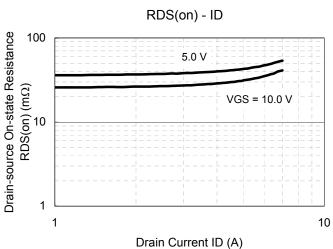
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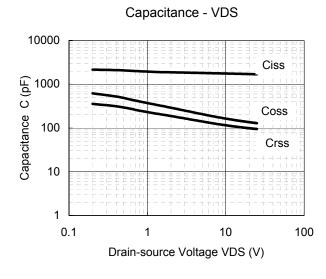
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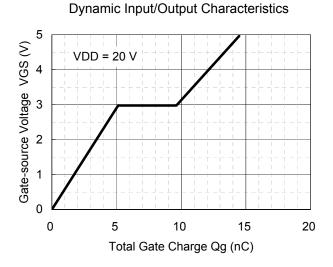








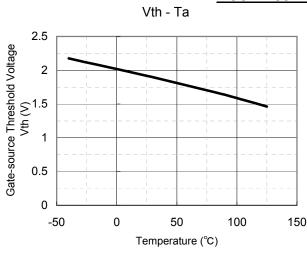


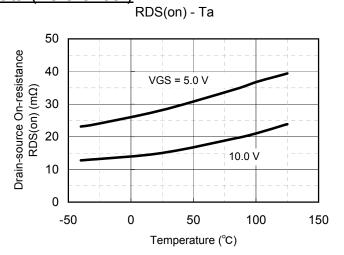


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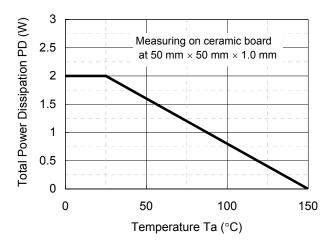
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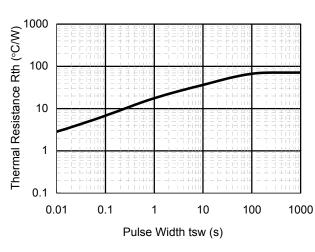




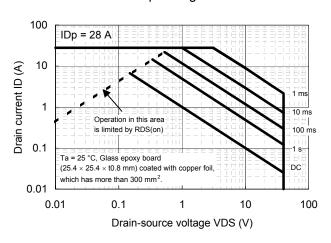
PD - Ta



Rth - tsw



Safe Operating Area



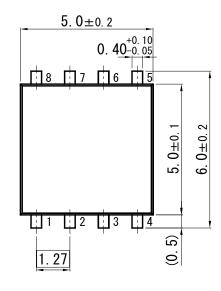
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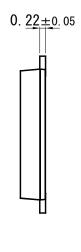
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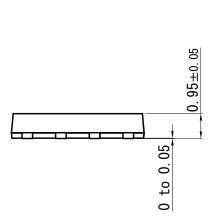
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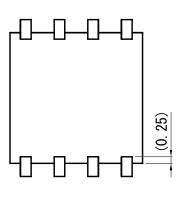
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Unit: mm

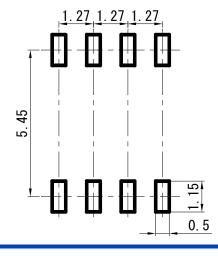








Land Pattern (Reference) (Unit : mm)



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